Unit: mm

TOSHIBA Photocoupler Photorelay

# **TLP4197G**

**PBX** 

Telecommunication

Modem·FAX Cards, Modems In PC

Measurement Instrumentation

The TOSHIBA TLP4197G consists of an infrared emitting diode optically coupled to a photo-MOSFET in a SOP, which is suitable for surface mount assembly.

The TLP4197GA is suitable for replacement of mechanical relays in many applications which require space savings.

• 6 pin SOP (2.54SOP6): 2.1 mm high, 2.54 mm pitch

• 1-form-B

Peak off-state voltage: 350 V (min)

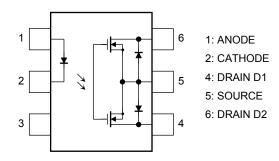
• Trigger LED current: 3 mA (max)

On-state current: 120 mA (max)

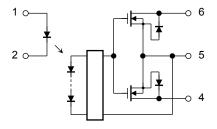
On-state resistance: 25 Ω (max)
Isolation voltage: 1500 Vrms (min)

• UL-recognized: UL 1577, File No.E67349

### Pin Configuration (top view)



#### **Schematic**



11-7C1

Weight: 0.13 g (typ.)

TOSHIBA

Start of commercial production 2001-05

## Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
	Forward current		lF	50	mA
	Forward current derating (Ta ≥ 25°C)		ΔIF/°C	-0.5	mA/°C
	Peak forward current (100 µs pulse, 100 pps)		IFP	1	Α
띰	Reverse voltage	•	V <sub>R</sub>	5	V
	Diode power dis	sipation	$P_D$	50	mW
	Diode power dis (Ta ≥ 25°C)	sipation derating	ΔP <sub>D</sub> /°C	-0.5	mW/°C
	Junction temper	ature	Tj	125	°C
	Off-state output	terminal voltage	Voff	350	V
		A connection		120	
	On-state current	B connection	ION	120	mA
		C connection		240	
	On-state current	A connection		-1.2	
	derating	B connection	Δlon/°C	-1.2	mA/°C
ctor	(Ta ≥ 25°C)	C connection		-2.4	
Detector		A connection	Po	360	
	Output power dissipation	B connection		201	mW
	·	C connection		403	
	Output power	A connection		-3.6	
	derating	B connection	ΔPo /°C	-2.0	mW /°C
		C connection		-4.0	
	Junction temperature		Tj	125	°C
Ope	rating temperatur	e range	T <sub>opr</sub>	-40 to 85	°C
Stora	age temperature	range	T <sub>stg</sub>	-55 to 125	°C
Lead	soldering tempe	rature (10 s)	T <sub>sol</sub>	260	°C
	tion voltage 60 s, R.H. ≤ 60 %	%) (Note 1)	BVS	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two-terminal device: LED side pins shorted together, and DETECTOR side pins and 6 shorted together.

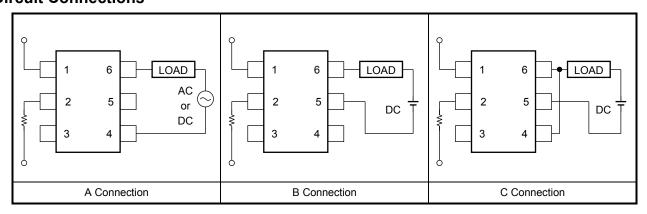
#### **Recommended Operating Conditions**

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	$V_{DD}$	_	_	280	٧
Forward current	lF	5	_	25	mA
On-state current	Ion	_	_	120	mA
Operating temperature	Topr	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.



#### **Circuit Connections**



#### **Electrical Characteristics (Ta = 25°C)**

	Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	10	μA
	Capacitance	CT	V <sub>F</sub> = 0 V, f = 1 MHz	_	30	_	pF
ctor	Off-state current	loff	V <sub>OFF</sub> = 350 V, I <sub>F</sub> = 5 mA	_	_	1	μΑ
Detector	Capacitance	Coff	V = 0 V, f = 1 MHz, I <sub>F</sub> = 5 mA	_	65	_	pF

# **Coupled Electrical Characteristics** (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current		IFC	IOFF = 10 μA	_	1	3	mA
Return LED current		lfT	ION = 120 mA	0.1	_	_	mA
	A connection	-	ION = 120 mA	_	15	25	
On-state resistance	B connection		ION = 120 mA	_	8	14	Ω
	C connection		I <sub>ON</sub> = 240 mA	_	4	_	

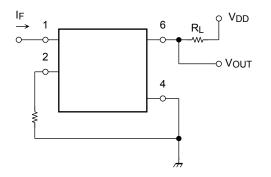
# **Isolation Characteristics (Ta = 25°C)**

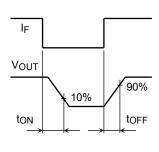
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	V <sub>S</sub> = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation resistance	Rs	V <sub>S</sub> = 500 V, R.H. ≦ 60 %	5 × 10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
Isolation voltage	BVs	AC, 60 s	1500	_	_	Vrms

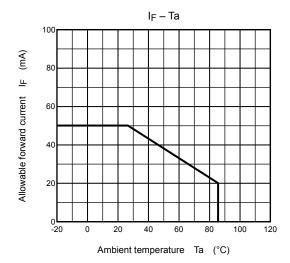
# **Switching Characteristics (Ta = 25°C)**

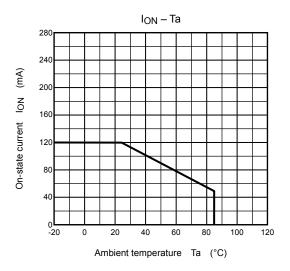
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	ton	$R_L = 200 \Omega$ (Note 2)	_	_	1	ms
Turn-off time	toff	$V_{DD}$ = 20 V, I <sub>F</sub> = 5 mA	_	_	3	ms

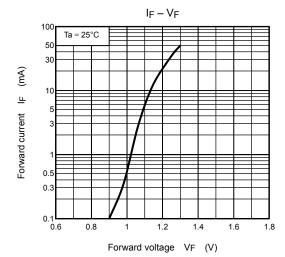
Note 2: Switching time test circuit

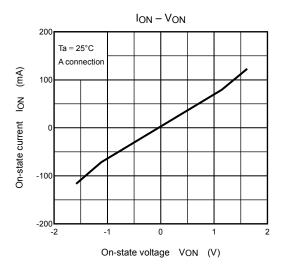


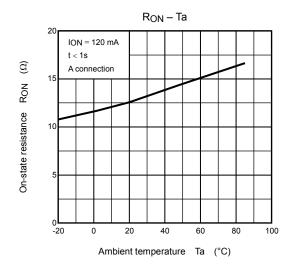


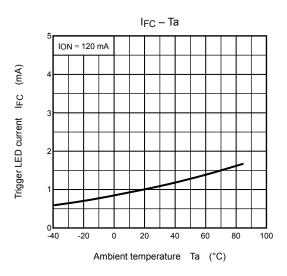




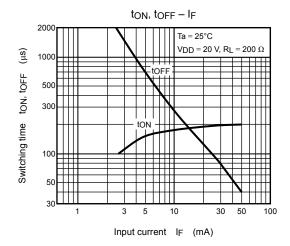


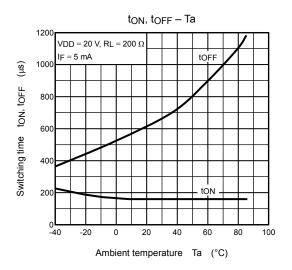


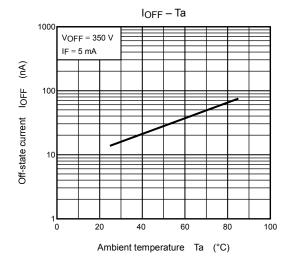




NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.







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